### INTERNATIONAL SEARCH REPORT

International application No. PCT/US00-15797

	SIFICATION OF SUBJECT MATTER		
110 (21	HO5H 1/00; H01L 21/00 156/345; 118/728E, 728R		
According to	International Patent Classification (IPC) or to both	national classification and IPC	
	DS SEARCHED		
Minimum do	cumentation searched (classification system followed	by classification symbols)	
	156/345; 118/728E, 723R		
Documentati searched	on searched other than minimum documentation to	the extent that such documents are ir	reluded in the fields
EAST	ata base consulted during the international search (na ems: plasma, electrode, endpoint, impedance	ime of data base and, where practicable	, search terms used)
C. DOC	UMENTS CONSIDERED TO BE RELEVANT		
Category*	Citation of document, with indication, where app	propriate, of the relevant passages	Relevant to claim No.
X	US 5,707,485 A (ROLFSON et al) 13.	January 1998, see cols. 5-6.	14
 Y			15-17
X. X	US 5,542,559 A (KAWAKAMI et al) US 5,576,629 A (TURNER et al) 1 entire document.		20 23-43
X Fur	ther documents are listed in the continuation of Box		
"A" d	ocument defining the general state of the art which is not considered to be of particular relevance arlier document published on or after the international filing date document which may throw doubts on priority claim(s) or which is	"T" later document published after the in date and not in conflict with the apthe principle or theory underlying t document of particular relevance, considered novel or cannot be considered to the considered to	plication but cited to undersiand the invention the claimed invention cannot be
"O" d	ited to establish the publication date of another citation of other pectal reason (as specified)  locument referring to an oral disclosure, use, exhibition or other means	"Y" document of particular relevance; considered to involve an inventive st with one or more other such docobvious to a person skilled in the a	op when the document is comouned uments, such combination being rt
b q	document published prior to the international filing date but later than the priority date claimed	"A" document member of the same pate	
	e actual completion of the international search	Date of mailing of the international	search report
02 AUG	GUST 2001	0 5 SEP 2001	
Commiss Box PCT	ton, D.C. 20231	Authorized officer  Thi Dang  Telephone No. (708) 808-0661	vall'z

### INTERNATIONAL SEARCH REPORT

International application No. PCT US00/18797

` (Continua	tion) DOCUMENTS CONSIDERED TO BE RELEVANT	
Category*	Citation of document, with indication, where appropriate of the relevant passages	Relevant to claim No.
X	US 5,480,052 A (FURR et al) 02 January 1996, see the entire	11,18
Y	document	4, 7, 9, 10, 12, 13, 15-17, 19

### ENT COOPERATION TREA

#### From the INTERNATIONAL BUREAU

#### **PCT**

#### **NOTIFICATION OF ELECTION**

(PCT Rule 61.2)

Commissioner
US Department of Commerce
United States Patent and Trademark
Office, PCT
2011 South Clark Place Room
CP2/5C24

Arlington, VA 22202 FTATS-UNIS D'AMERIQUE

Date of mailing (day/month/year) 10 July 2001 (10.07.01)	in its capacity as elected Office		
International application No. PCT/US00/18797	Applicant's or agent's file reference NOR-933WO		
International filing date (day/month/year) 10 July 2000 (10.07.00)	Priority date (day/month/year) 13 July 1999 (13.07.99)		
Applicant			
TYLER, James, Scott			

1.	The designated Office is hereby notified of its election made:
	X in the demand filed with the International Preliminary Examining Authority on:
	12 February 2001 (12.02.01)
	in a notice effecting later election filed with the International Bureau on:
2.	The election X was was not
	made before the expiration of 19 months from the priority date or, where Rule 32 applies, within the time limit under Rule 32.2(b).

The International Bureau of WIPO 34, chemin des Colombettes 1211 Geneva 20, Switzerland Authorized officer

H. Zhou

Telephone No.: (41-22) 338.83.38

Facsimile No.: (41-22) 740.14.35

# **PCT**

REC'D 2 0 NOV 2001

MIPO POT

# INTERNATIONAL PRELIMINARY EXAMINATION REPORT

(PCT Article 36 and Rule 70)

Applicant's or agent's file reference NOR-933WO	FOR FURTHER ACTION		cation of Transmittal of International Examination Report (Form PCT/IPEA/416)	
International application No.	International filing date (day/	month/year)	Priority date (day/month/year)	
PCT/US00/18797	10 JULY 2000		18 JULY 1999	
International Patent Classification (IPC) IPC(7): H05H 1/00; H01L 21/00 and				
Applicant NORDSON CORPORATION				
<ol> <li>This international preliming Examining Authority and is</li> <li>This REPORT consists of a</li> </ol>	transmitted to the applicant		ed by this International Preliminary Article 36.	
been amended and are the (see Rule 70.16 and Section	e basis for this report and/or sh on 607 of the Administrative I	eets containing	ription, claims and/or drawings which have g rectifications made before this Authority. der the PCI).	
These annexes consist of a tot	al of <u>U</u> sheets.			
3. This report contains indication	s relating to the following its	ems:		
I X Basis of the repor	rt .			
П Priority				
III Non-establishmen	it of report with regard to no	velty, inventi	ve step or industrial applicability	
IV Lack of unity of	invention	•		
	t under Article 35(2) with rega		inventive step or industrial applicability;	
VI Certain documents of	eited			
VII Certain defects in the	ne international application			
	s on the international applicati	On.		
	on the memorial approximation			
Date of submission of the demand	Date	of completion	of this report	
12 FEBRUARY 2001	12 FEBRUARY 2001 \$1 OCTOBER 2001			
Name and mailing address of the IPEA/US Authorized officer				
Box PCT	Commissioner of Patents and Trademarks Box PCT Washington, D.C. 20231			
Facsimile No. (703) 305-3230	Telep	hone No. (7	(05) \$08-0661	



mernational application No.

PCT/US00/18797

I.	Ba	isis d	of the repo	ort				
1	With	regai	rd to the ele	ments of the intern	ational application	nn:*		
1.	$\mathbf{x}$	~		al application as				
			description		2 ,			
	X		es					, as originally filed
		-	es					, filed with the demand
			es					
	_							
	X		claims:	21 42				
			es	31-42 NONE				, as originally filed
		-	es	NONE				statement) under Article 19, filed with the demand
			es		. filed w	ith the letter of		, med with the demand
		r-6-			, ,			
	$\mathbf{x}$	the	drawings:					
		page	es	1-8				, as originally filed
			es	NONE				, filed with the demand
		page	es	NONE		, filed with the l	letter of	
	<u> </u>	.L.	1:	-4:	1:-4:			
	X		es	sting part of the o	=			, as originally filed
				NONE				, filed with the demand
						, filed with the l	etter of	, mod with the demand
	The:	se eler the la the la	ments were anguage of anguage of	available or furnis f a translation fu f publication of	hed to this Auth irnished for th the internation	e purposes of intended application (u	ng language ernational search ( nder Rule 48.3(b))	which is: funder Rule 23.1(b)).  armination (under Rules 55.2 and/
3.		_	-			sequence disclosed asis of the sequence		l application, the international
	Ш	conta	ained in th	e international a	pplication in	printed form.		
	$\Box$	filed	together v	with the internati	onal applicati	on in computer re	eadable form.	
	同	furni	shed subse	equently to this	Authority in w	ritten form.		
	$\overline{\Box}$	furni	shed subse	equently to this	Authority in c	omputer readable	form.	
		The s	statement ti national ap	hat the subsequer plication as filed	itly furnished v has been furni	written sequence li shed.	isting does not go b	beyond the disclosure in the
		The s been	statement th furnished.	at the information	recorded in co	mputer readable fo	orm is identical to the	e writen sequence listing has
4	X	The	amendmer	nts have resulted	in the cancel	lation of:		
• •		X	the descr	ription, pages	NONE			
		X			NONE	<del></del>		
		$\overline{\nabla}$		ns, Nos ings, sheets <del>/fig</del>	NONE			
5.		TL		_			L	
J.	Ш					endments had not t Supplemental Box		y have been considered to go
*	in th	ceme	nt sheets whoort as "ori	ich have been furni	shed to the recei	iving Office in respo	nse to an invitation w	nder Article 14 are referred to ain amendments (Rules 70.16
*				et containing such	amendments m	ust be referred to	under item I and an	nexed to this report.



International application No.

YES

NO

PCT/US00/18797

V.	Reasoned statement under Article 35(2) with regard to novelty, inventive step or industrial applicability;
	citations and explanations supporting such statement

	5 such statement	• •
1. statement		
Novelty (N)	Claims 1-19, 21, 22 Claims 11-14, 20, 23-43	YES NO
Inventive Step (IS)	Claims 1-10, 15-19, 21, 22 Claims 11-14, 20, 23-43	YES NO
Industrial Applicability (IA)	Claims 1-43	YTho

### 2. citations and explanations (Rule 70.7)

Claims 1-10, 15-19, 21, and 22 meet the criteria set out in PCT Article 33(2)-(4), because the prior art does not teach or fairly suggest a plasma processing apparatus having a vacuum distribution baffle arranged between the vacuum port and the workpiece holder, and a powered electrode positioned between the vacuum baffle and the workpiece holder.

NONE

Claims

Claim 20 lacks novelty under PCT Article 35(2) as being anticipated by Kawakami et al.

Kawakami discloses a plasma processing method that includes supplying process gas through an array of apertures facing the workpiece, and applying power to generate plasma from the process gas.

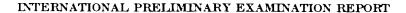
Claims 23-45 lack novelty under PCT Article 55(2) as being anticipated by Turner et al.

Turner discloses a method of detecting an endpoint of a plasma treatment which includes all of the claimed features including matching the impedance to a desired value and controlling the RF power. Controlling the RF power would include increasing the RF power.

Claim 1+ lacks an inventive step under PCT Article 33(3) as being obvious over Rolfson et al.

Rolfson discloses a plasma processing apparatus that has two electrodes arranged on opposite sides of a workpiece, and power supply means for applying power to the electrodes so as to generate plasma between the electrodes. Even though the power supply is connected to both electrodes in Rolfson's apparatus, it would have been obvious to have one of the electrodes grounded because it is known in the art that plasma can be generated between a powered electrode and a grounded electrode.

Claims 11, 12, 13 lack an inventive step under PCT Article 33(3) as being obvious over Furr et al. (Continued on Supplemental Sheet.)



International application No.

PCT/US00/18797

Supplemental Box

(To be used when the space in any of the preceding boxes is not sufficient)

Continuation of: Boxes I - VIII

Sheet 10

#### V. 2. REASONED STATEMENTS - CITATIONS AND EXPLANATIONS (Continued):

Furr discloses a plasma processing chamber having a chamber lid, which is connected to the chamber base by a hinge. It would have been obvious to provide a sealing member and abround bearing groove for the hinge of Furr's apparatus because these features are conventional in the art to provide proper closing of the chamber lid.

US 5,707,485 A (ROLFSON et al) 13 January 1998, see cols. 5-6.
US 5,542,559 A (KAWAKAMI et al) 06 August 1996, see cols. 5-6.

US 5,576,629 A (TURNER et al) 19 November 1996, see the entire document.

US 5,480,052 A (FURR et al) 02 January 1996, see the entire document.

### (12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

#### (19) World Intellectual Property Organization International Bureau



### - 1**700/6 0/700/**6 12 0/6/14 00/10 10/10 10/10 00/10 00/10 10/10 10/10 10/10 10/10 10/10 10/10 10/10 10/10 10/10

#### (43) International Publication Date 18 January 2001 (18.01.2001)

#### **PCT**

#### (10) International Publication Number WO 01/05197 A2

(51) International Patent Classification7:

H<sub>05</sub>H

[US/US]; 141 South Emerald Oak Drive, Galt, CA 95632

(21) International Application Number: PCT/US00/18797

(22) International Filing Date:

10 July 2000 (10.07.2000)

(25) Filing Language:

English

(26) Publication Language:

English

(30) Priority Data:

60/143,577

13 July 1999 (13.07.1999)

(71) Applicant (for all designated States except US): NORD-SON CORPORATION [US/US]; 28601 Clemens Avenue, Westlake, OH 44145 (US).

(72) Inventor; and

(75) Inventor/Applicant (for US only): TYLER, James, Scott

(US).

(74) Agents: ROONEY, Kevin, G. et al.; Wood, Herron & Evans, L.L.P., 2700 Carew Tower, Cincinnati, OH 45202 (US).

(81) Designated States (national): JP, KR, US.

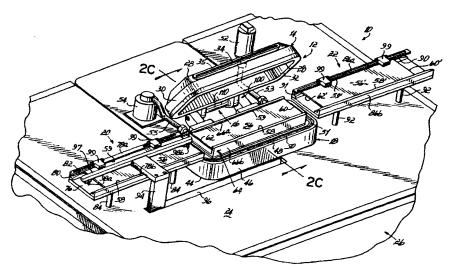
(84) Designated States (regional): European patent (AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE).

#### Published:

Without international search report and to be republished upon receipt of that report.

For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.

(54) Title: HIGH-SPEED SYMMETRICAL PLASMA TREATMENT SYSTEM



(57) Abstract: A plasma treatment system (10) and related methods for rapidly treating a workpiece (56) with ions from a plasma having an ion density that is reproducibly uniform and symmetrical. The processing chamber (12) of the plasma treatment system (10) includes a chamber (14) lid having a symmetrical array of apertures (192) and further includes a vacuum distribution baffle (180), which are both configured to uniformly disperse a process gas adjacent the surface of the workpiece (56). The uniform dispersion of process gas and a symmetrical placement of the workpiece within the chamber (12) contribute to providing a uniformly dense plasma of ions adjacent the workpiece (56). A treatment system control (304) automates the operation of the system and controls the flow of process gas, evacuation of the chamber, and the application of the plasma excitation power to minimize the length of a treatment cycle and to optimize the uniformity of the plasma treatment.



## . PATENT COOPERATION TREATY

# **PCT**

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## INTERNATIONAL PRELIMINARY EXAMINATION REPORT

(PCT Article 36 and Rule 70)

Applicant's or agent's file reference NOR-933WO	FOR FURTHER ACTION See Notification of Transmittal of Internation Preliminary Examination Report (Form PCT/IPEA/-	
International application No. PCT/US00/18797	International filing date (day/month/year) 10 JULY 2000	Priority date (day/month/year) 18 JULY 1999
International Patent Classification (IPC) IPC(7): H05H 1/00; H01L 21/00 and	or national classification and IPC US Cl.: 156/3+5; 118/723E, 723R	
Applicant NORDSON CORPORATION		
2. This REPORT consists of a This report is also accompage amended and are the	transmitted to the applicant according total of sheets.  canied by ANNEXES, i.e., sheets of the december of this report and/or sheets containing to 607 of the Administrative Instructions upon 607 of the	scription, claims and/or drawings which have no rectifications made before this Authority
3. This report contains indications	-	
I X Basis of the repor  II Priority  III Non-establishmen  IV Lack of unity of i  V X Reasoned statement citations and explan  VI Certain documents ci  VII Certain defects in the	t of report with regard to novelty, inven nvention under Article 35(2) with regard to novelty ations supporting such statement	tive step or industrial applicability  of, inventive step or industrial applicability;  ORRECTED  VERSION
Date of submission of the demand	Date of completion	n of this report
12 FEBRUARY 2001	31 OCTOBER	
Commissioner of Patents and Trademarks Box PCT Washington, D.C. 20231  acsimile No. (708) 805-8280  Authorized officer Thi Dang Thi Dang Telephone No. (703) 308-0661		

## INTERNATIONAL PRELIMINARY EXAMINATION REPORT

International	application	No.

#### PCT/US00/18797

. Ba	sis of the report	
1. With	regard to the elements of the international application:*	
	the international application as originally filed	
	the description:	
X	(See Attached)	, as originally filed
		_ , liled with the demand
	pages, filed with the letter of	
$\lceil x \rceil$	the claims:	
	(See Attached)	, as originally filed
	pages, as amended (together with any	filed with the demand
	pages, filed with the letter of	, filed with the distance
	pages, filed with the letter of	
$\lceil x \rceil$	the drawings:	11-11-11-14
ث	(See Attached)	, as originally filed
	pages	, Theu with the demand
	pages, filed with the letter of	
$\left[ \mathbf{x} \right]$	the sequence listing part of the description:	
	(See Attached)	, as originally filed
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	pages, filed with the letter of	
	the language of a translation furnished for the purposes of international search the language of publication of the international application (under Rule 48.3(b)) the language of the translation furnished for the purposes of international preliminary expression (55.3).	).
3. W	ith regard to any <b>nucleotide and/or amino acid sequence</b> disclosed in the internation reliminary examination was carried out on the basis of the sequence listing:	nal application, the international
	contained in the international application in printed form.	
	filed together with the international application in computer readable form.	
<u> </u>	furnished subsequently to this Authority in written form.	
누	furnished subsequently to this Authority in computer readable form.	
	The statement that the subsequently furnished written sequence listing does not go	beyond the disclosure in the
	The statement that the information recorded in computer readable form is identical to been furnished.	the writen sequence listing has
. Гъ	7 mg to the concellation of	
4. <u>X</u>	NONE	
	the description, pages	
	the claims, 140s.	
, r	X the drawings, sheets/fig NONE  This report has been drawn as if (some of) the amendments had not been made, since the state of the st	they have been considered to go
5.	- 1 1 1 1 1 1 1 1 1 1 2 1 2 1 2 1 2 1 2	
in	eplacement sheets which have been furnished to the receiving Office in response to an invitation this report as "originally filed" and are not annexed to this report since they do not co	ontain amendments (Rules 70.16
**A	ny replacement sheet containing such amendments must be referred to under item 1 and	annexed to this report.

#### INTERNATIONAL PRELIMINARY EXAMINATION REPORT

International application No.

PCT/US00/18797

V.	Reasoned statement under Article 35(2) with regard to novelty, inventive step or industrial applic	ability;
	citations and explanations supporting such statement	

1. stateme	Ii l	t
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Novelty (N)	Claims	1-10, 15-19, 21-22	YES
Claims	11-14, 20, 23-43	NO	
Inventive Step (IS)	Claims	1-10, 15-19, 21-22	YES
	Claims	11-14, 20, 28-48	NO
In the second American district (IA)	Claims	1-48	YES
Industrial Applicability (IA)	Claims	NONE	NO

#### 2. citations and explanations (Rule 70.7)

Claims 1-10, 15-19, 21, and 22 meet the criteria set out in PCT Article 38(2)-(4), because the prior art does not teach or fairly suggest a plasma processing apparatus having a vacuum distribution baffle arranged between the vacuum port and the workpiece holder, and a powered electrode positioned between the vacuum baffle and the workpiece holder.

Claim 20 lacks novelty under PCT Article 33(2) as being anticipated by Kawakami et al.

Kawakami discloses a plasma processing method that includes supplying process gas through an array of apertures facing the workpiece, and applying power to generate plasma from the process gas.

Claims 23-43 lack novelty under PCT Article 33(2) as being anticipated by Turner et al.

Turner discloses a method of detecting an endpoint of a plasma treatment which includes all of the claimed features including matching the impedance to a desired value and controlling the RF power. Controlling the RF power would include increasing the RF power.

Claim 14 lacks an inventive step under PCT Article 38(3) as being obvious over Rolfson et al.

Rolfson discloses a plasma processing apparatus that has two electrodes arranged on opposite sides of a workpiece, and power supply means for applying power to the electrodes so as to generate plasma between the electrodes. Even though the power supply is connected to both electrodes in Rolfson's apparatus, it would have been obvious to have one of the electrodes grounded because it is known in the art that plasma can be generated between a powered electrode and a grounded electrode.

Claims 11, 12, 13 lack an inventive step under PCT Article 35(3) as being obvious over Furr et al. (Continued on Supplemental Sheet.)

#### INTERNATIONAL PRELIMINARY EXAMINATION REPORT

International application No.

PCT/US00/18797

#### Supplemental Box

(To be used when the space in any of the preceding boxes is not sufficient)

Continuation of: Boxes I - VIII

Sheet 10

#### I. BASIS OF REPORT:

This report has been drawn on the basis of the description, page(s) 1-30, as originally filed. page(s) NONE, filed with the demand, and additional amendments:

NONE

This report has been drawn on the basis of the claims, page(s) 31-33, 35, 38, 41-42, as originally filed. page(s) NONE, as amended under Article 19. page(s) NONE, filed with the demand. and additional amendments:
Pages 34, 36-37a, 39-40a, filed with the letter of 05 October 2001.

This report has been drawn on the basis of the drawings, page(s) 1-8, as originally filed. page(s) NONE, filed with the demand, and additional amendments:

NONE

This report has been drawn on the basis of the sequence listing part of the description: page(s) NONE, as originally filed, pages(s) NONE, filed with the demand, and additional amendments:

NONE

#### V. 2. REASONED STATEMENTS - CITATIONS AND EXPLANATIONS (Continued):

Furr discloses a plasma processing chamber having a chamber lid, which is connected to the chamber base by a hinge. It would have been obvious to provide a sealing member and abround bearing groove for the hinge of Furr's apparatus because these features are conventional in the art to provide proper closing of the chamber lid.

US 5,707,485 A (ROLFSON et al) 13 January 1998, see cols. 5-6.

US 5,542,559 A (KAWAKAMI et al) 06 August 1996, see cols. 5-6.

US 5,576,629 A (TURNER et al) 19 November 1996, see the entire document.

US 5,480,052 A (FURR et al) 02 January 1996, see the entire document.

14. An apparatus for processing a workpiece with a process gas, comprising:

a chamber having a processing space and a workpiece holding portion configured to receive the workpiece;

a gas supply in fluid communication with the vacuum chamber, said gas supply operable to selectively provide a process gas into the processing space;

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a powered electrode positioned on one side of said workpiece holding portion;

a plasma excitation source operably connected to said powered electrode assembly for exciting the process gas within said processing space to generate a plasma; and

a ground electrode positioned on an opposite side of said workpiece holding portion relative to said powered electrode, said powered electrode and said ground electrode being approximately equidistant from said workpiece holding portion, said powered and ground electrodes together producing an electric field substantially perpendicular to said workpiece when said workpiece is received in said workpiece holding portion.

- 15. The apparatus of claim 14, wherein said chamber includes a lid movable between open and closed positions for introducing and removing the workpiece to and from said workpiece holding portion of said processing space, said lid further comprising said ground electrode.
  - 16. The apparatus of claim 15, wherein said lid further includes a process gas inlet port for introducing process gas to said processing space.

- 19. The apparatus of claim 18, wherein said lid includes an interior surface facing said workpiece holding portion of said processing space when said lid is in said closed position, and said process gas inlet port further comprises a gas distribution space within said lid and an array of apertures on said interior surface configured to uniformly distribute the process gas from said gas distribution space onto the workpiece.
- 20. A method for treating a workpiece with a plasma, comprising: positioning a workpiece on a workpiece-holding portion within a processing space of a vacuum chamber, said vacuum chamber having an interior surface facing said workpiece holding portion wherein said interior surface including an array of apertures configured to uniformly distribute said process gas about said surface of said workpiece;

evacuating the processing space;

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initiating a flow of a process gas through said array of apertures into the processing space, wherein said flow lines of process gas are symmetrical over the surface of the workpiece; and

applying plasma excitation power to create a plasma from the process gas in the processing space.

21. A method for treating a workpiece with a plasma, comprising:

positioning a workpiece on a workpiece-holding portion within a

processing space of a vacuum chamber;

initiating a flow of a process gas into said processing space
evacuating the processing space through a vacuum port in fluid
communication with said vacuum chamber, said chamber further including a
vacuum distribution baffle positioned between said vacuum port and said
workpiece-holding portion, wherein said baffle provides symmetrical lines of
flow of said process gas over said surface of said workpiece; and

applying plasma excitation power to create a plasma from the process gas in the processing space.

- 22. The method of claim 21, wherein said vacuum distribution baffle comprises an electrically-insulating material and said baffle is operable to confine said plasma to a portion of said processing space adjacent said workpiece holding portion.
- 5 23. A method of operating a plasma treatment system comprising: transferring a workpiece to be processed into a processing chamber;

decreasing pressure within the processing chamber;
initiating a flow of process gases into the processing chamber;
applying an RF power of a relatively-low power level to
electrodes within the processing chamber to create a gas plasma, thereby

matching an impedance of an RF system including the electrodes at the relatively-low power level to a desired impedance;

initiating a plasma treatment cycle;

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increasing RF power to the electrodes from the relatively-low power level to a relatively-high power level;

continuously matching the impedance of the RF system to the desired impedance while increasing the RF power to the electrodes;

maintaining the RF power at the relatively-high power level; continuously matching the impedance while maintaining the RF

power to the electrodes at or near the relatively-high power level;

detecting an end of the plasma treatment cycle; and terminating the flow of process gases to the processing chamber and the application of RF power to the electrodes after detecting the end of the plasma treatment cycle.

24. The method of operating a plasma treatment system of claim 23 further comprising decreasing RF power to the electrodes in response to detecting an end of the plasma treatment cycle.

25. The method of operating a plasma treatment system of claim 23 further comprising increasing RF power to the electrodes at a maximum rate permitting a continuous matching of the impedance of the RF system to the desired impedance.

30. A method of operating a plasma treatment system comprising: transferring a workpiece to be processed into a processing chamber;

evacuating the processing chamber to an upper pressure limit; initiating a flow of process gases into the processing chamber; applying RF power to electrodes within the processing chamber to create a gas plasma, thereby initiating a plasma treatment cycle; matching an impedance of an RF system including the

matching an impedance of an RF system including the electrodes to a desired impedance;

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continuing to evacuate the processing chamber during the plasma treatment cycle to a pressure greater than or equal to a lower pressure limit while continuously matching the impedance of the RF system to the desired impedance;

detecting an end of the plasma treatment cycle; and terminating the flow of process gases to the processing chamber and the application of RF power to the electrodes after detecting the end of the plasma treatment cycle.

- 31. The method of operating a plasma treatment system of claim 30 further comprising the steps of monitoring pressure within the processing chamber at least between the upper and lower pressure limits and controlling the flow of process gases into the processing chamber based on the monitored pressure.
- 32. The method of operating a plasma treatment system of claim 30 wherein the upper pressure limit equals a normally used processing pressure value plus an incremental offset pressure value.
- 33. The method of operating a plasma treatment system of claim 32 wherein the lower pressure limit equals the normally used processing pressure value minus the increment offset pressure value.

34. The method of operating a plasma treatment system of claim 33 further comprising increasing pressure in the processing chamber after detecting the end of the plasma treatment cycle.

35. A method of operating a plasma treatment system comprising: transferring a workpiece to be processed into a processing chamber;

operating a vacuum system to decrease pressure within the processing chamber to a first partial vacuum;

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operating a mass flow controller to initiate a flow of process gases into the processing chamber;

operating in response to the first partial vacuum in the chamber an RF generator to apply RF power of a lesser, first power level to electrodes within the processing chamber to create a gas plasma, thereby initiating a plasma treatment cycle;

operating a tuning network to match an impedance of an RF system including the RF generator and the electrodes to a desired impedance with the electrodes being supplied the first power level;

operating the RF generator to increase RF power to the electrodes to a greater, second power level;

operating the tuning network to match the impedance of the RF system to the desired impedance with the electrodes being supplied with the second power level;

operating the RF generator to maintain the RF power at the greater, second power level;

operating the vacuum system and the mass flow controller to decrease pressure within the processing chamber to a second partial vacuum;

continuously operating the tuning network to match the impedance of the RF system to the desired impedance while maintaining the RF power to the electrodes at the greater, second power level;

detecting an end of the plasma treatment cycle;

operating the mass flow controller to terminate the flow of process gases to the processing chamber after detecting the end of the plasma treatment cycle;

operating the RF generator to terminate the application of RF power to the electrodes after detecting the end of the plasma treatment cycle; and

increasing pressure within the processing chamber to approximately atmospheric pressure.